

April 2015

FDB110N15A — N-Channel PowerTrench[®] MOSFET

FDB110N15A N-Channel PowerTrench[®] MOSFET 150 V, 92 A, 11 m Ω

Features

- $R_{DS(on)}$ = 9.25 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 92 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

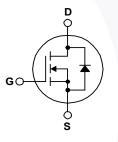
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FDB110N15A	Unit	
V _{DSS}	Drain to Source Voltage		150	V		
V _{GSS}	Cata to Source Valtage	- DC	- DC		V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	v	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		92	A	
	Drain Current	- Continuous (T _C = 100 ^o C)	1.	65		
I _{DM}	Drain Current	- Pulsed	(Note 1)	369	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			365	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6	V/ns		
P _D	Power Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		234	W	
	Power Dissipation	- Derate Above 25°C		1.56	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

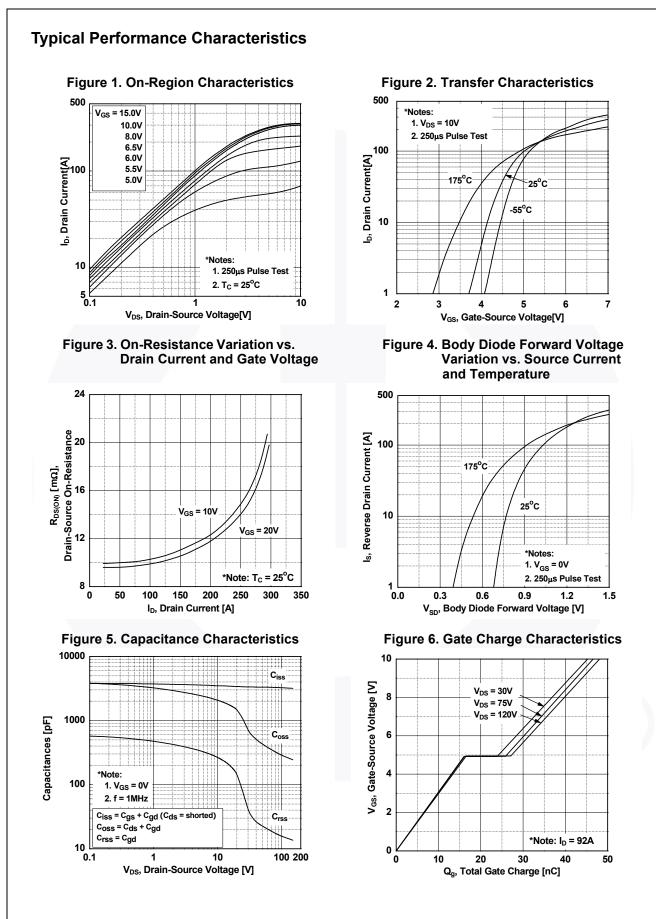
Thermal Characteristics

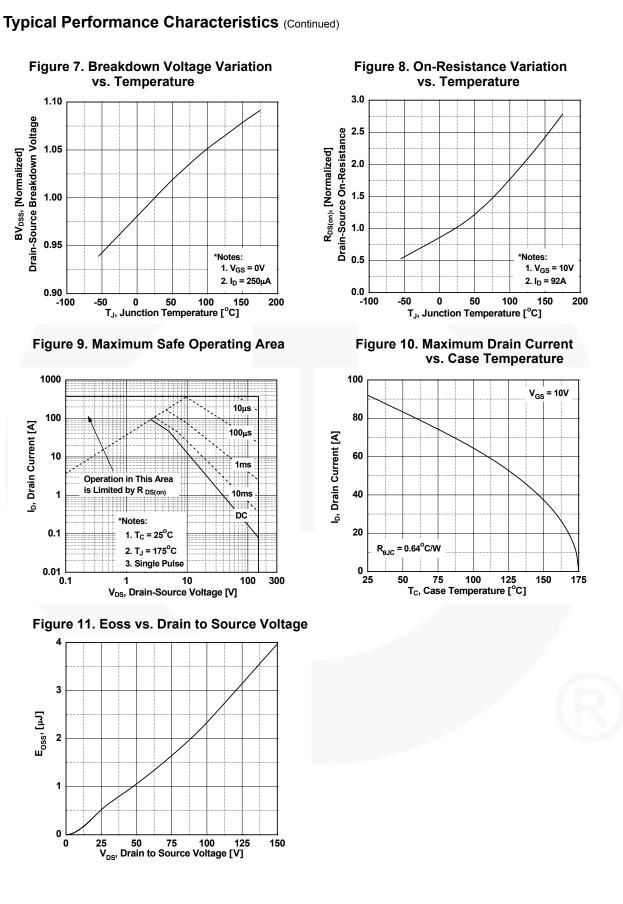
Symbol	Parameter	FDB110N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.64	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max. 6		°C/W

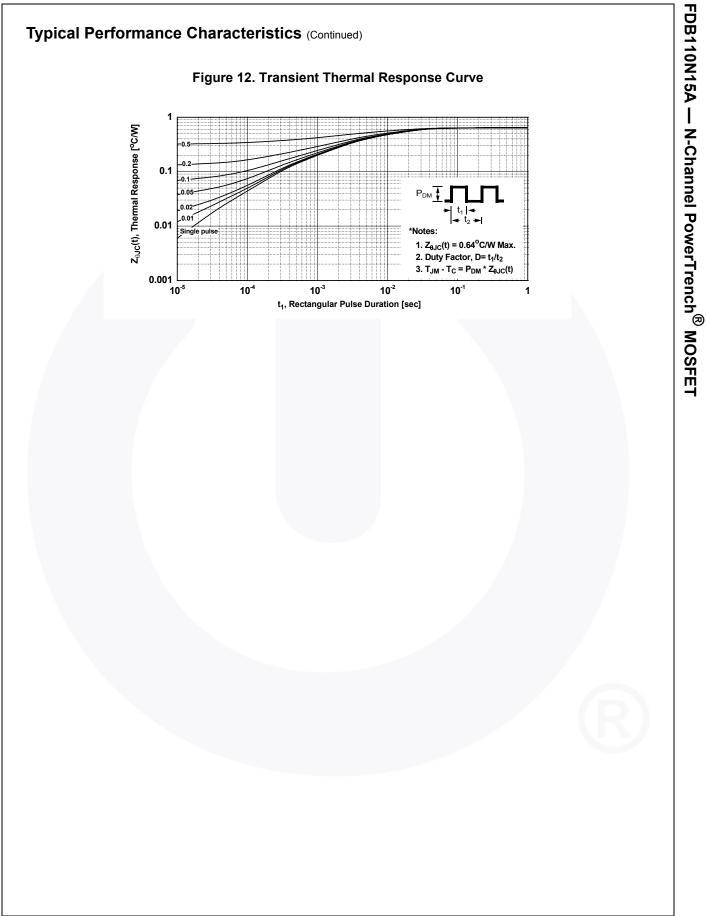
Part Nun	nber	Top Mark	Package	ckage Packing Method Reel Size		Тар	e Width	Qua	ntity
FDB110N	•		D ² -PAK	v		24 mm		800 units	
Electrica	I Char	acteristics T _C = 2	5°C unless o	therwise noted.					
Symbol		Parameter		Test Cond	litions	Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
BV _{DSS}	Drain to	Source Breakdown Volt	age	I _D = 250 μA, V _{GS} = 0) V	150	-	-	V
ΔBV _{DSS} / ΔT _J		own Voltage Temperature		$I_D = 250 \ \mu\text{A}, \ \text{Referenced to } 25^{\circ}\text{C}$		-	0.09	-	V/ºC
1	Zoro Co	Zero Gate Voltage Drain Current		V _{DS} = 120 V, V _{GS} = 0 V		-	-	1	
DSS	Zero Ga	ite voltage Drain Curren		V _{DS} = 120 V, T _C = 1	50°C	-	-	500	μA
I _{GSS}	Gate to	Gate to Body Leakage Current		$V_{GS} = \pm 20 V, V_{DS} = 0 V$		-	-	±100	nA
On Charac	teristics	6							
V _{GS(th)}	Gate Th	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250$	μA	2.0	-	4.0	V
R _{DS(on)}		rain to Source On Resist		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 92$		-	9.25	11.0	mΩ
9FS	Forward	I Transconductance		$V_{\rm DS}$ = 10 V, I _D = 92		-	118	-	S
Dynamic C	haracte	eristics							
C _{iss}	Input Ca	apacitance		V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-	3390	4510	pF
C _{oss}	Output 0	Capacitance				-	334	445	pF
C _{rss}	Reverse	Transfer Capacitance				-	14	-	pF
C _{oss} (er)	Engry R	eleted Output Capacitan	се	V _{DS} = 75 V, I _D = 92	A	-	583	-	pF
Q _{g(tot)}	Total Ga	te Charge at 10V		$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 75 \text{ V},$ $I_D = 92 \text{ A}$ (Note 4)		-	47	61	nC
Q _{gs}	Gate to	Source Gate Charge				-	16	-	nC
Q _{gs2}	Gate Ch	arge Threshold to Plate	au			-	7.9	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	9.7	-	nC
Switching	Charact	teristics							
t _{d(on)}	-	Delay Time				-	25	60	ns
t _r		Rise Time		V_{DD} = 75 V, I _D = 92 A, V_{GS} = 10 V, R _G = 4.7 Ω (Note 4)		-	26	62	ns
t _{d(off)}	Turn-Off	Delay Time				-	46	102	ns
t _f	Turn-Off	Fall Time				-	14	38	ns
ESR	Equivale	ent Series Resistance (G	-S)	f = 1 MHz	(-	2.5	-	Ω
Drain Sou		le Characteristics					1		
s			ource Diode	Forward Current			-	92	Α
I _{SM}		ximum Continuous Drain to Source Diode Forward Current		-	-	369	A		
V _{SD}		Source Diode Forward \				-	-	1.25	V
t _{rr}		Recovery Time	0	$V_{GS} = 0 V, I_{SD} = 92 A, V_{DD} = 75 V, \ dI_F/dt = 100 A/\mu s$		-	89	-	ns
Q _{rr}		Recovery Charge				-	255	-	nC
Notes: 1. Repetitive rating 2. L = 3 mH, I_{AS} = 3. $I_{SD} \le 92$ A, di/dt	: pulse width- 15.6 A, R _G = ≤ 200 A/µs, V	limited by maximum junction terr 25 Ω , starting T _J = 25°C. $t_{DD} \leq BV_{DSS}$, starting T _J = 25°C. erating temperature typical characteristics	perature.				200	Œ	

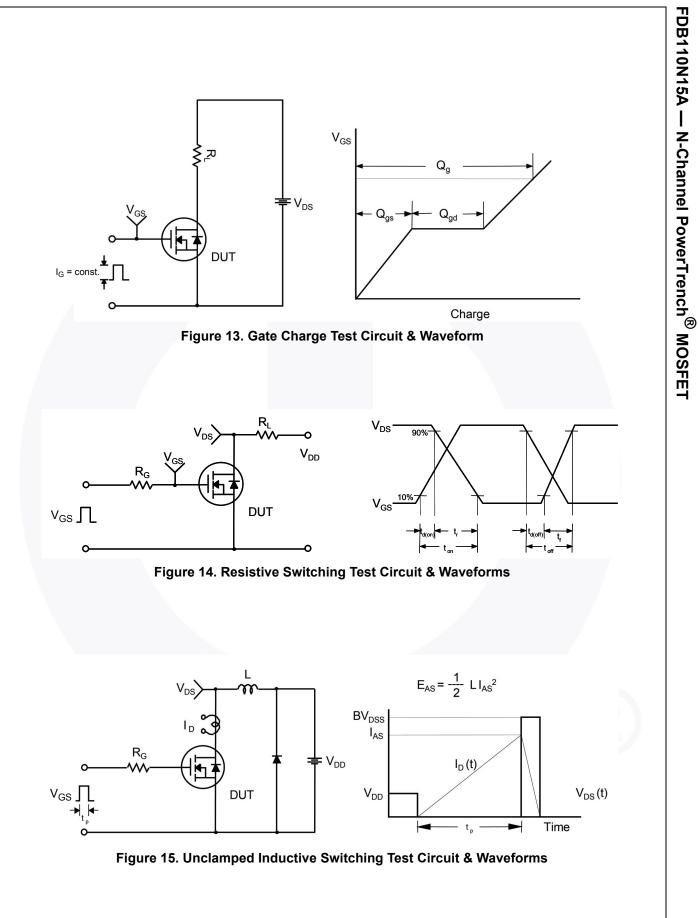
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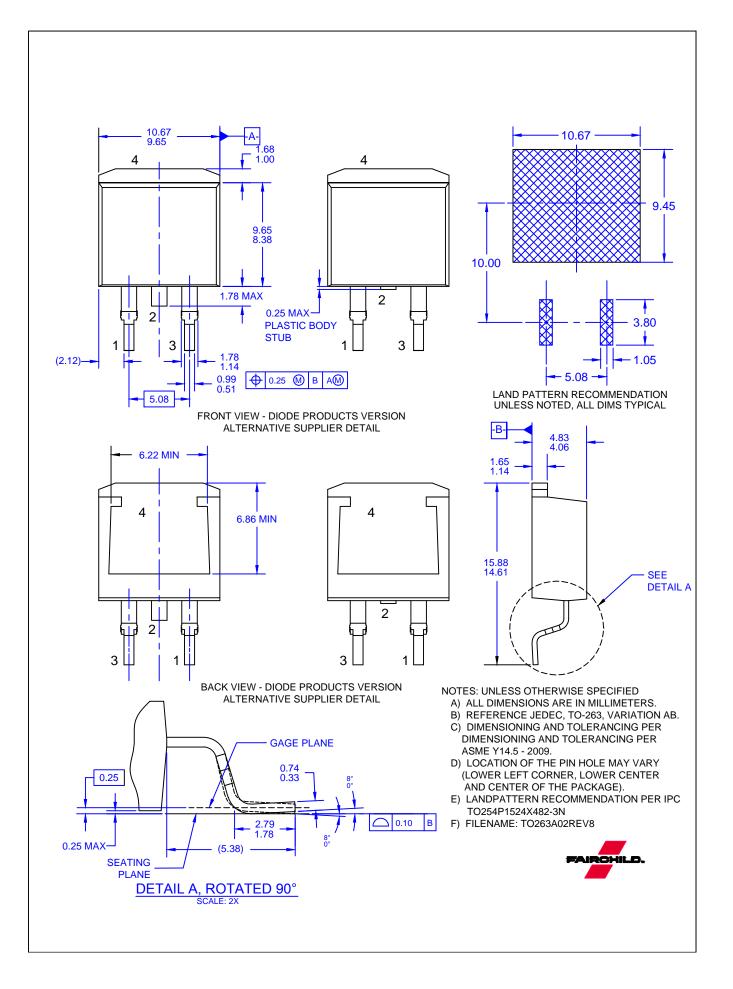






DUT + v_{DS} a ۱_{SD} م L Driver R_G, Same Type as DUT L F V_{DD} $\prod V_{GS}$ • dv/dt controlled by R_G • I_{SD} controlled by pulse period Î Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) I_{FM}, Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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